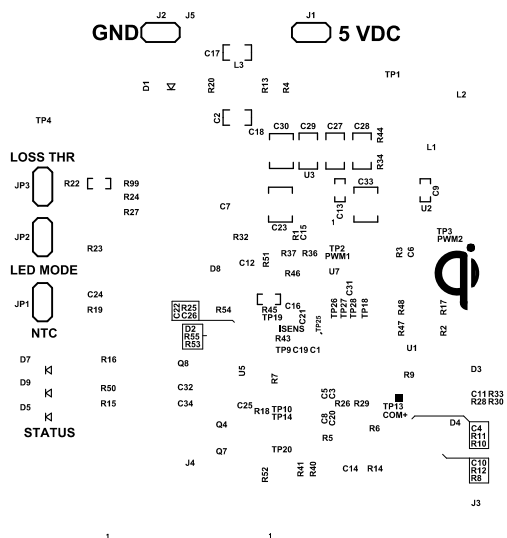
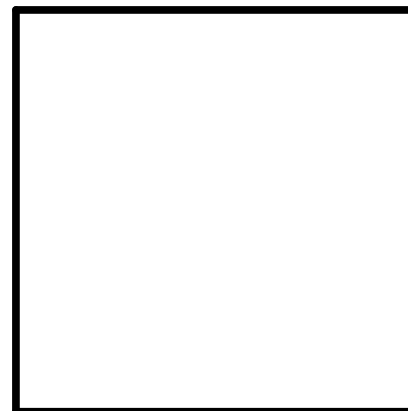




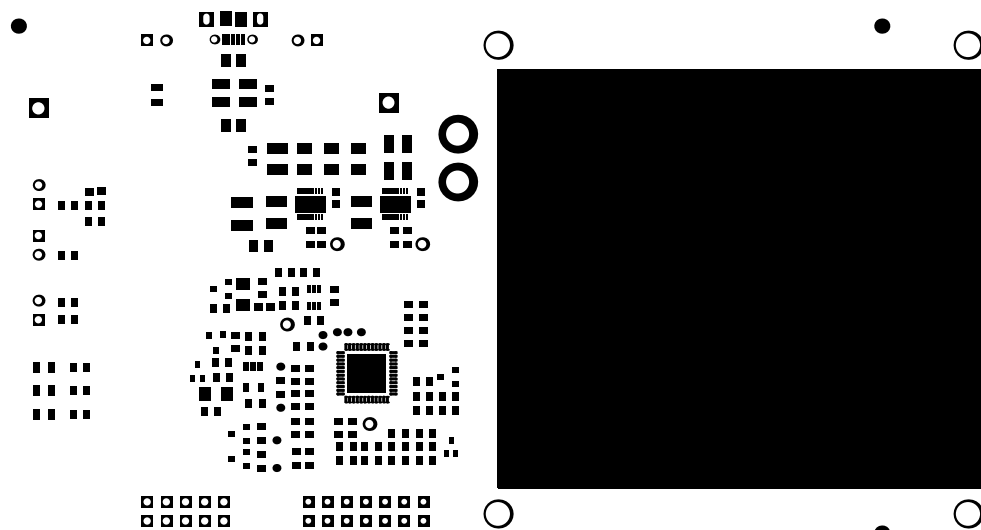
TEXAS INSTRUMENTS



bq500212AEVM-550
PWR550A

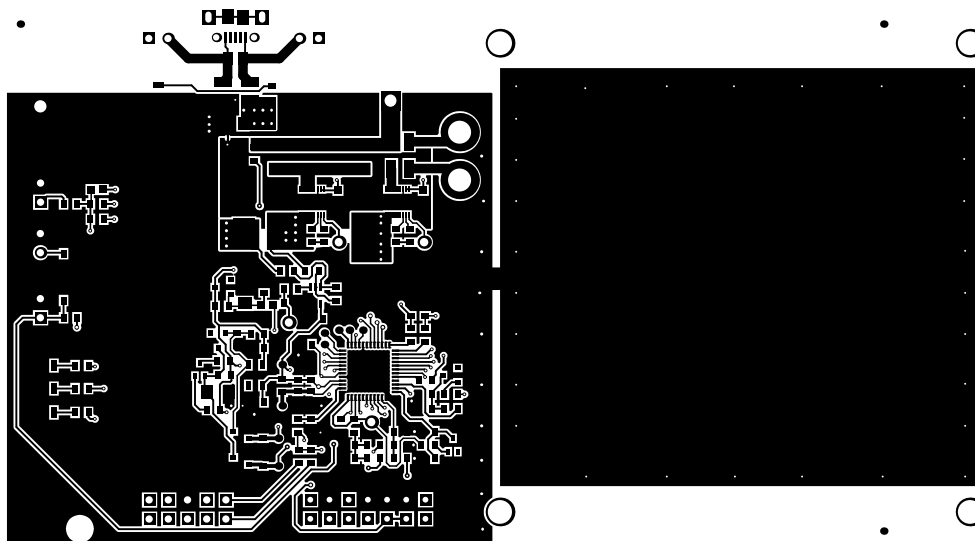
TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 6/13/2013 3:01:30 PM	TEXAS INSTRUMENTS	



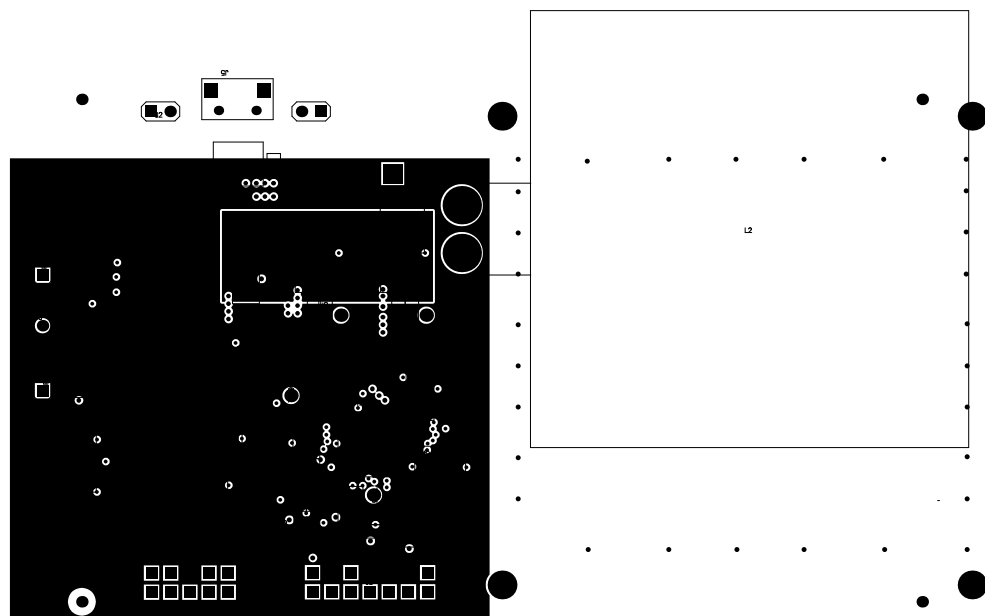
TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 6/13/2013 3:01:30 PM	TEXAS INSTRUMENTS	



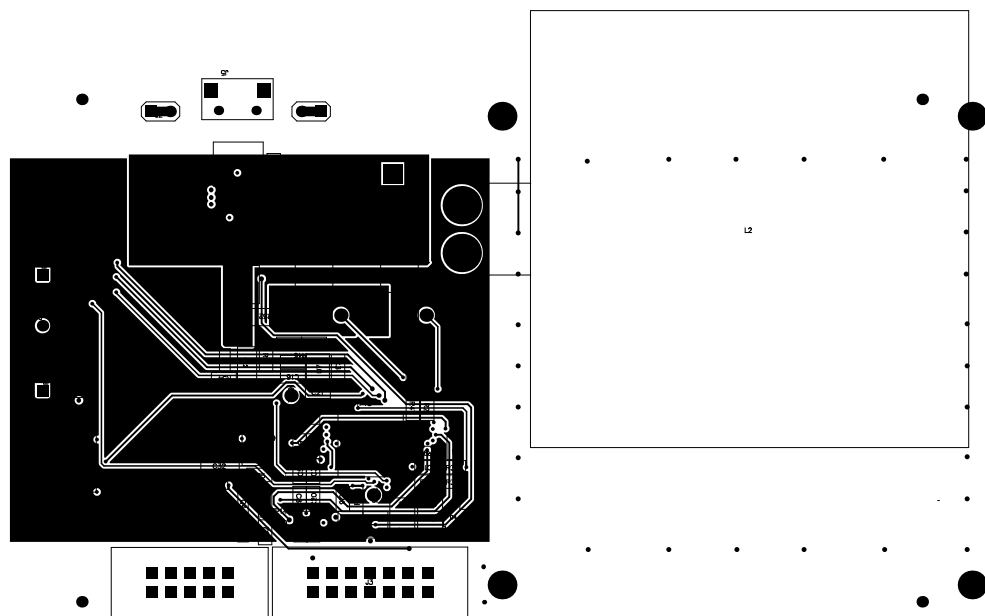
TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 6/13/2013 3:01:31 PM	TEXAS INSTRUMENTS	



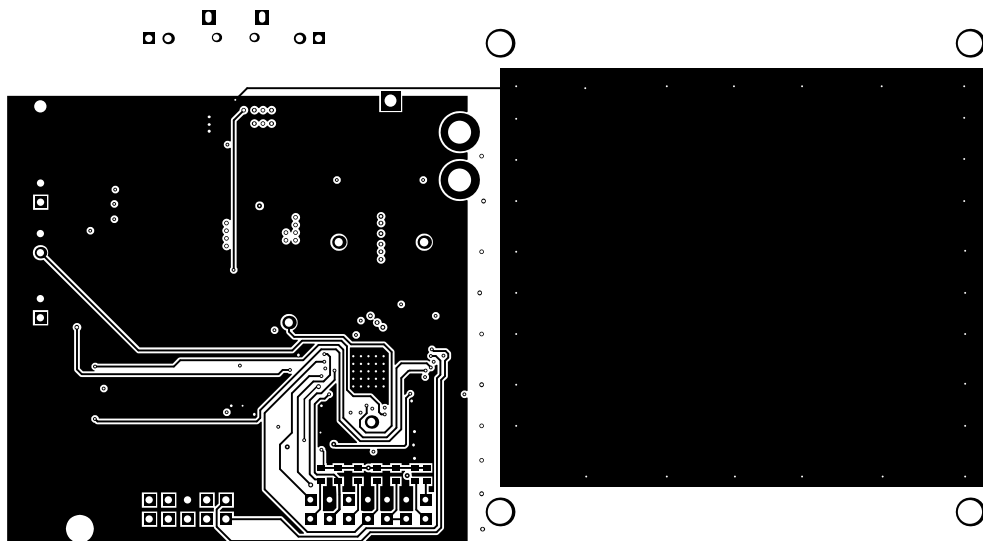
TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = INTERNAL 1			
PLOT NAME = Internal 1	GENERATED : 6/13/2013 3:01:32 PM	TEXAS INSTRUMENTS	



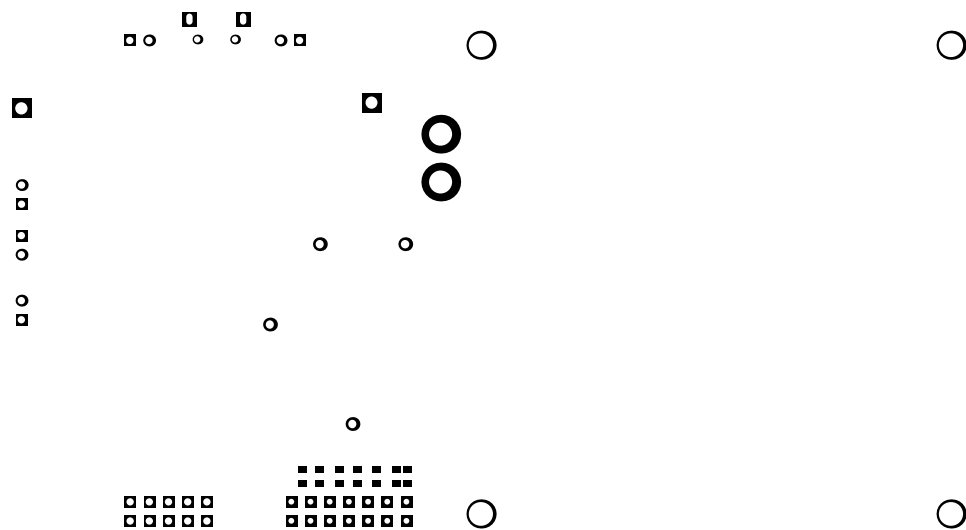
TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = INTERNAL 2			
PLOT NAME = Internal 2	GENERATED : 6/13/2013 3:01:32 PM	TEXAS INSTRUMENTS	



TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 6/13/2013 3:01:33 PM	TEXAS INSTRUMENTS	



TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 6/13/2013 3:01:33 PM	TEXAS INSTRUMENTS	

1545
1546
1547
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1550
1551

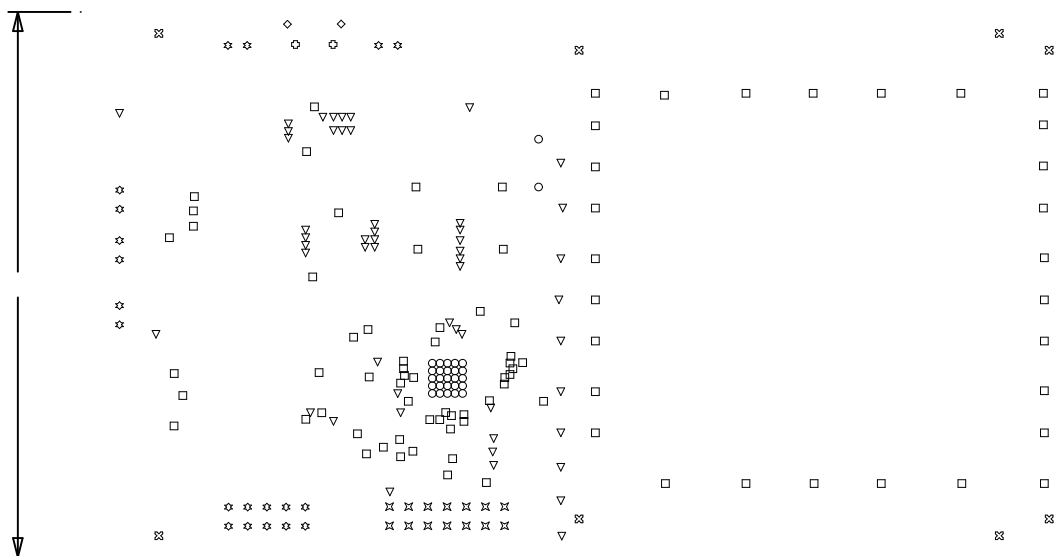
TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 6/13/2013 3:01:34 PM	TEXAS INSTRUMENTS	

Symbol	Hit Count	Tool Size	Physical Length	Rout Path Length	Plated	Hole Type
□	81	10mil (0.254mm)			PTH	Round
○	25	11.811mil (0.3mm)			PTH	Round
▽	50	15mil (0.381mm)			PTH	Round
⊗	14	30mil (0.762mm)			PTH	Round
⊕	2	33.465mil (0.85mm)			NPTH	Round
☆	20	38mil (0.965mm)			PTH	Round
□	4	43mil (1.092mm)			PTH	Round
▽	2	63mil (1.6mm)			PTH	Round
○	2	120mil (3.048mm)			PTH	Round
⊗	8	125mil (3.175mm)			NPTH	Round
◇	2	33.465mil (0.85mm)	59.055mil (1.5mm)	25.59mil (0.65mm)	PTH	Slot
	210 Total					

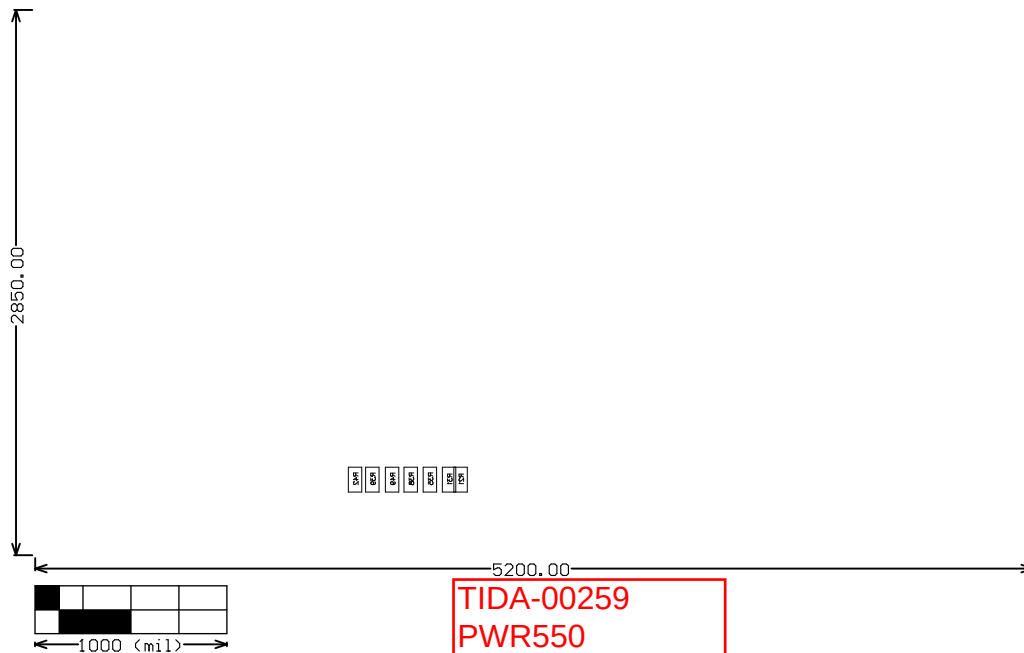
Slot definitions : Rout Path Length = Calculated from tool start centre position to tool end centre position.

Physical Length = Rout Path Length + Tool Size = Slot length as defined in the PCB layout



TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PR550	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 6/13/2013 3:01:35 PM	TEXAS INSTRUMENTS	



TIDA-00259
PWR550

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	PR550	REV:	A	SUN REV:	Not In VersionControl
LAYER NAME = M2 Board Dimensions						
PLOT NAME = Board Dimensions	GENERATED	: 6/13/2013	3:01:35 PM	TEXAS INSTRUMENTS		

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